



GreenMOS™

## OSG65R290FTF\_Datasheet



# Enhancement Mode N-Channel Power MOSFET

## Features

- ◆ Low  $R_{DS(on)}$  & FOM
- ◆ Extremely low switching loss
- ◆ Excellent stability and uniformity
- ◆ Easy to drive

## Applications

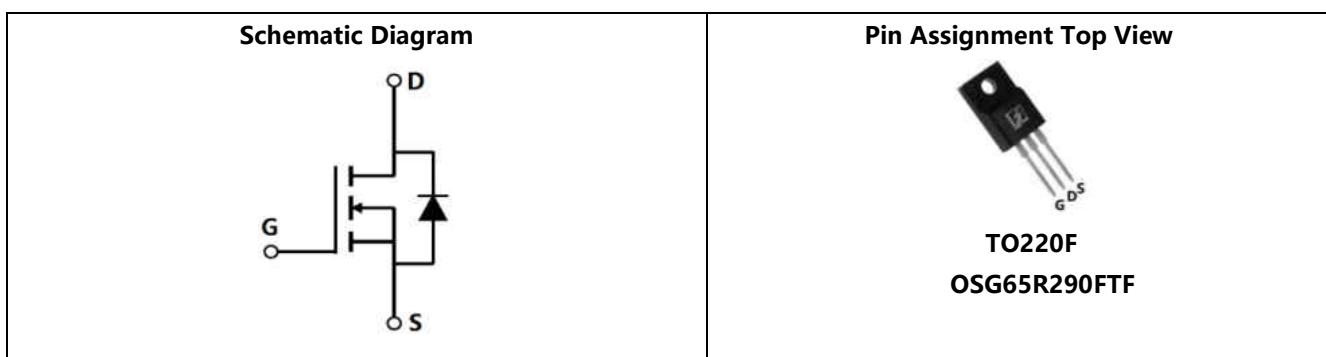
- ◆ Lighting
- ◆ Hard switching PWM
- ◆ Server power supply
- ◆ Charger

## ■ General Description

OSG65R290FTF uses advanced GreenMOS™ technology to provide low  $R_{DS(ON)}$ , low gate charge, fast switching and excellent avalanche characteristics. This device is suitable for active power factor correction and switching mode power supply applications.

◆ $V_{DS, min@Tjmax}$	700 V
◆ $I_D, pulse$	45 A
◆ $R_{DS(ON)}, \text{max @ } VGS=10 \text{ V}$	290 mΩ
◆ $Q_g$	19.2 nC

## ■ Schematic and Package Information



## ■ Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	Value	Unit
Drain source voltage	$V_{DS}$	650	V
Gate source voltage	$V_{GS}$	$\pm 30$	V
Continuous drain current <sup>1)</sup> , $T_C=25^\circ\text{C}$	$I_D$	15	A
Continuous drain current <sup>1)</sup> , $T_C=100^\circ\text{C}$		9.5	
Pulsed drain current <sup>2)</sup> , $T_C=25^\circ\text{C}$	$I_{D, \text{pulse}}$	45	A
Continuous diode forward current <sup>1)</sup> , $T_C=25^\circ\text{C}$	$I_S$	15	A
Diode pulsed current <sup>2)</sup> , $T_C=25^\circ\text{C}$	$I_{S, \text{Pulse}}$	45	A
Power dissipation <sup>3)</sup> , $T_C=25^\circ\text{C}$	$P_D$	31	W
Single pulsed avalanche energy <sup>5)</sup>	$E_{AS}$	212	mJ
MOSFET dv/dt ruggedness, $V_{DS}=0...480 \text{ V}$	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS}=0...480 \text{ V}, I_{SD} \leq I_D$	dv/dt	15	V/ns
Operation and storage temperature	$T_{stg}, T_j$	-55 to 150	°C

## ■ Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal resistance, junction-case	$R_{\theta JC}$	4	°C/W
Thermal resistance, junction-ambient <sup>4)</sup>	$R_{\theta JA}$	62.5	°C/W

## ■ Electrical Characteristics at $T_j=25$ °C unless otherwise specified

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Drain-source breakdown voltage	$BV_{DSS}$	650			V	$V_{GS}=0$ V, $I_D=250$ μA
		700				$V_{GS}=0$ V, $I_D=250$ μA, $T_j=150$ °C
Gate threshold voltage	$V_{GS(th)}$	3.0		4.0	V	$V_{DS}=V_{GS}$ , $I_D=250$ μA
Drain-source on-state resistance	$R_{DS(ON)}$		0.26	0.29	Ω	$V_{GS}=10$ V, $I_D=5$ A
			0.71			$V_{GS}=10$ V, $I_D=5$ A, $T_j=150$ °C
Gate-source leakage current	$I_{GSS}$			100	nA	$V_{GS}=30$ V
				-100		$V_{GS}=-30$ V
Drain-source leakage current	$I_{DSS}$			1	uA	$V_{DS}=650$ V, $V_{GS}=0$ V
Gate resistance	$R_G$		30		Ω	$f=1$ MHz, Open drain

## ■ Dynamic Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Input capacitance	$C_{iss}$		875		pF	$V_{GS}=0$ V, $V_{DS}=50$ V, $f=100$ KHz
Output capacitance	$C_{oss}$		64		pF	
Reverse transfer capacitance	$C_{rss}$		2.9		pF	
Turn-on delay time	$t_{d(on)}$		30		ns	$V_{GS}=10$ V, $V_{DS}=400$ V, $R_G=2$ Ω, $I_D=8$ A
Rise time	$t_r$		24.5		ns	
Turn-off delay time	$t_{d(off)}$		72		ns	
Fall time	$t_f$		19		ns	

## ■ Gate Charge Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Total gate charge	$Q_g$		19.2		nC	$I_D=8\text{ A}$ , $V_{DS}=400\text{ V}$ , $V_{GS}=10\text{ V}$
Gate-source charge	$Q_{gs}$		6.3		nC	
Gate-drain charge	$Q_{gd}$		3.2		nC	
Gate plateau voltage	$V_{plateau}$		5.7		V	

## ■ Body Diode Characteristics

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test condition
Diode forward voltage	$V_{SD}$			1.3	V	$I_S=15\text{ A}$ , $V_{GS}=0\text{ V}$  $V_R=400\text{ V}$ , $I_S=8\text{ A}$ , $di/dt=100\text{ A}/\mu\text{s}$
Reverse recovery time	$t_{rr}$		252		ns	
Reverse recovery charge	$Q_{rr}$		2.6		$\mu\text{C}$	
Peak reverse recovery current	$I_{rrm}$		20		A	

## ■ Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3)  $P_d$  is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of  $R_{\theta JA}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25\text{ }^{\circ}\text{C}$ .
- 5)  $V_{DD}=100\text{ V}$ ,  $R_G=50\text{ }\Omega$ ,  $L=79.9\text{ mH}$ , starting  $T_j=25\text{ }^{\circ}\text{C}$ .

## ■ Electrical Characteristics Diagrams

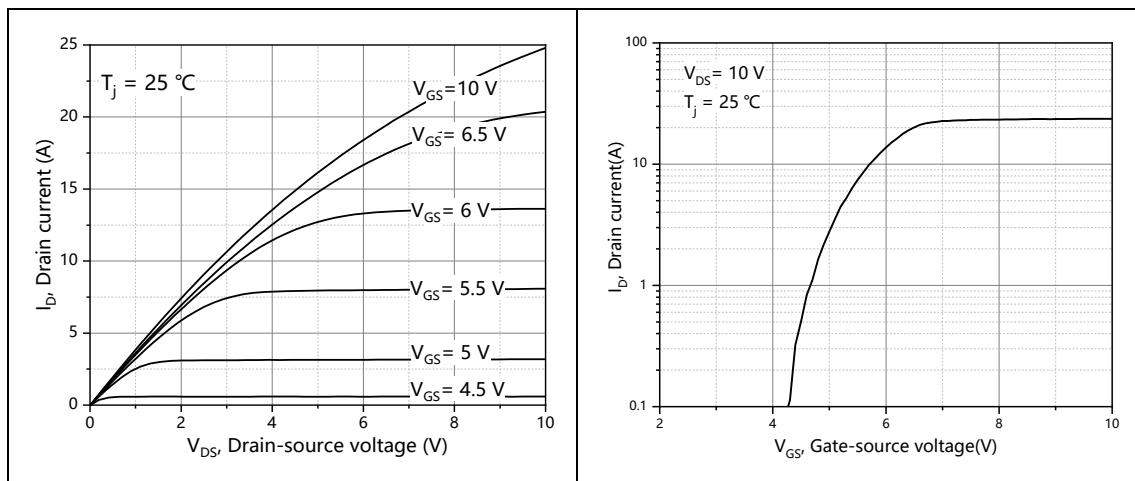


Figure 1, Typ. output characteristics

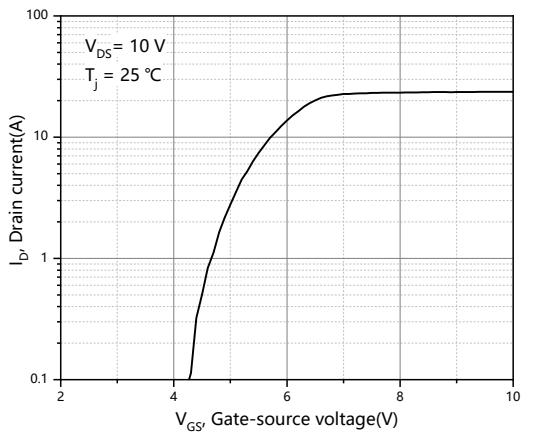


Figure 2, Typ. transfer characteristics

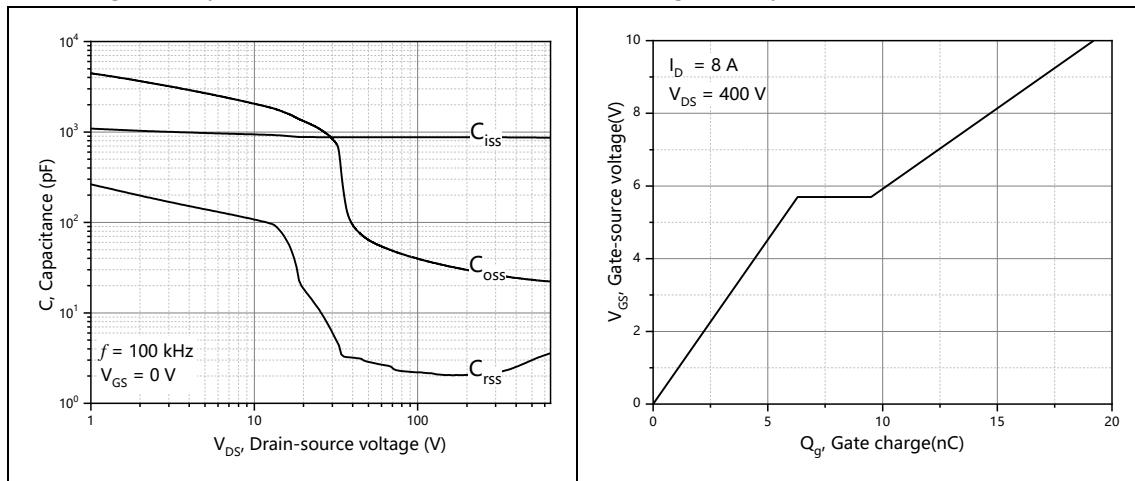


Figure 3, Typ. capacitances

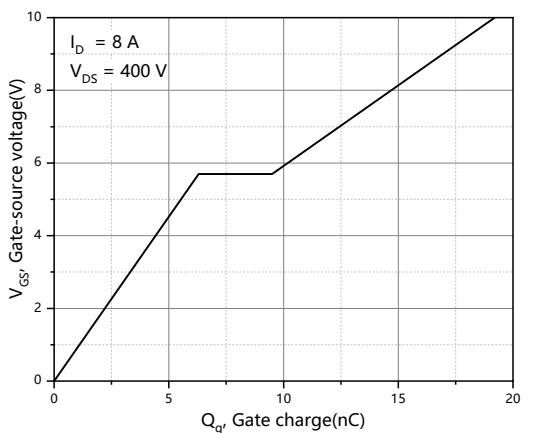


Figure 4, Typ. gate charge

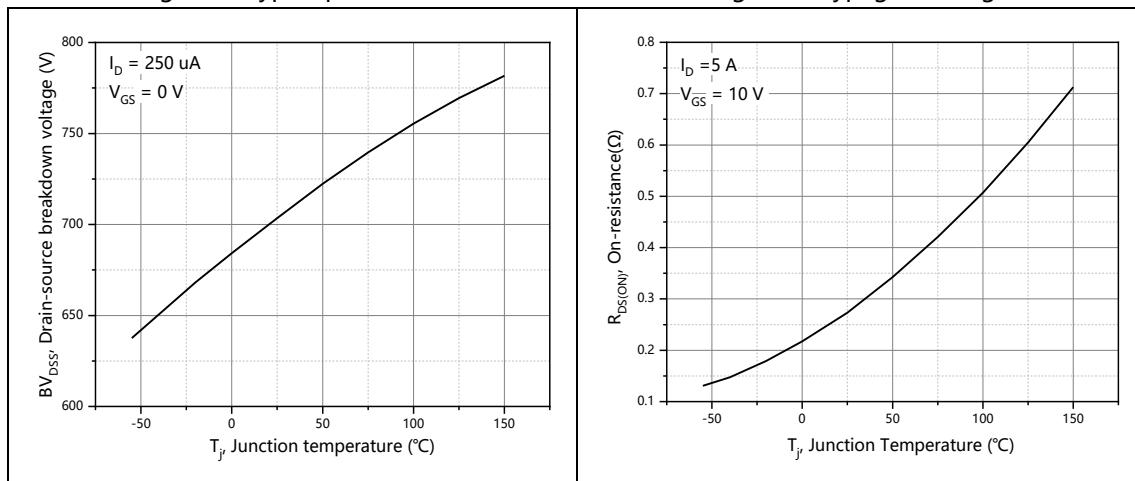


Figure 5, Drain-source breakdown voltage

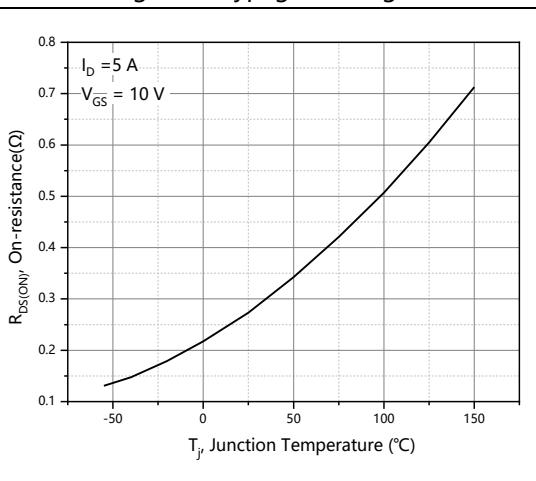


Figure 6, Drain-source on-state resistance

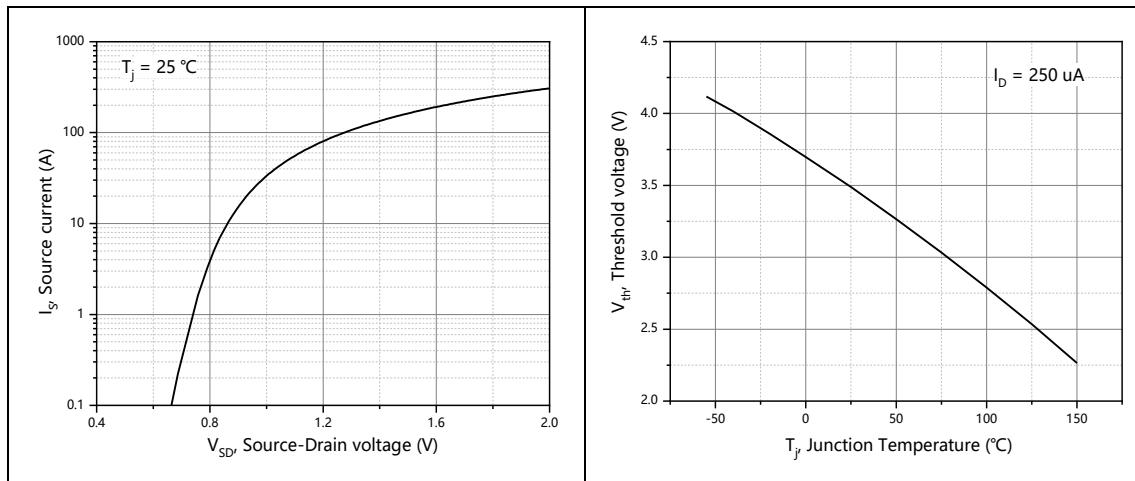


Figure 7, Forward characteristic of body diode

Figure 8, Threshold voltage

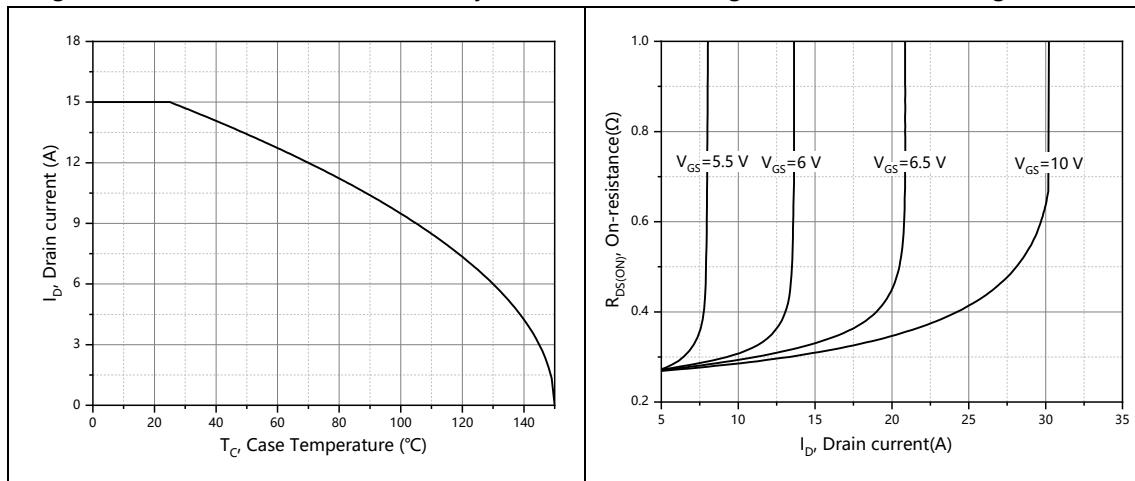


Figure 9, Drain current

Figure 10, Drain-source on-state resistance

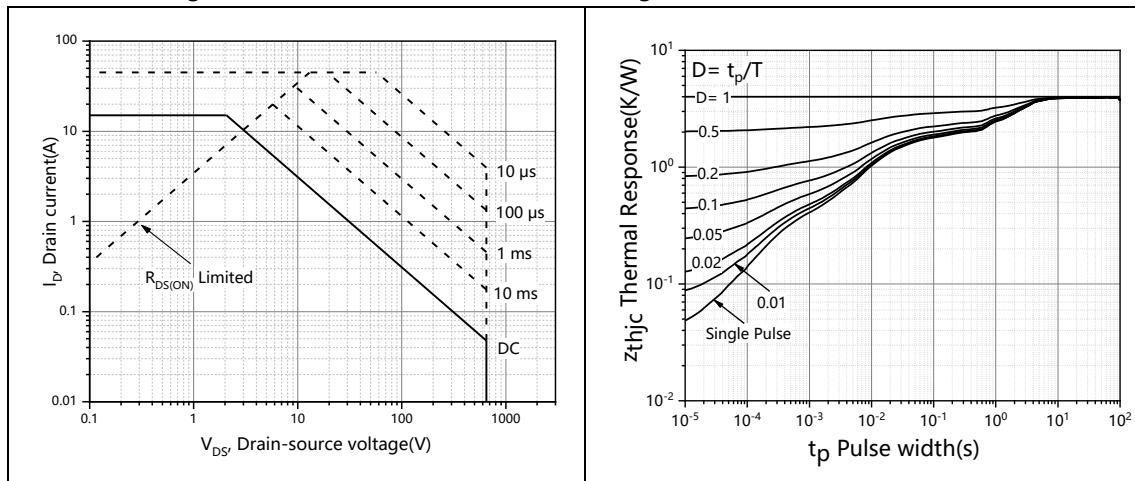
Figure 11, Safe operation area for  $T_C=25\text{ }^{\circ}\text{C}$ 

Figure 12, Max. transient thermal impedance

## ■ Test circuits and waveforms

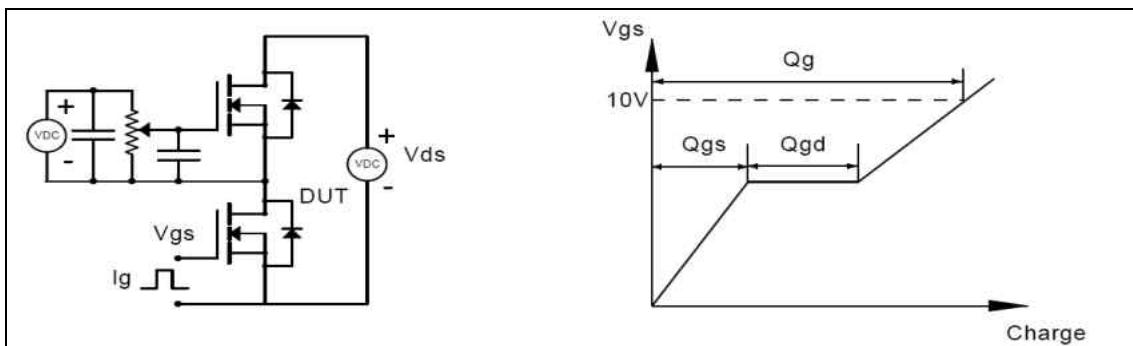


Figure 1, Gate charge test circuit & waveform

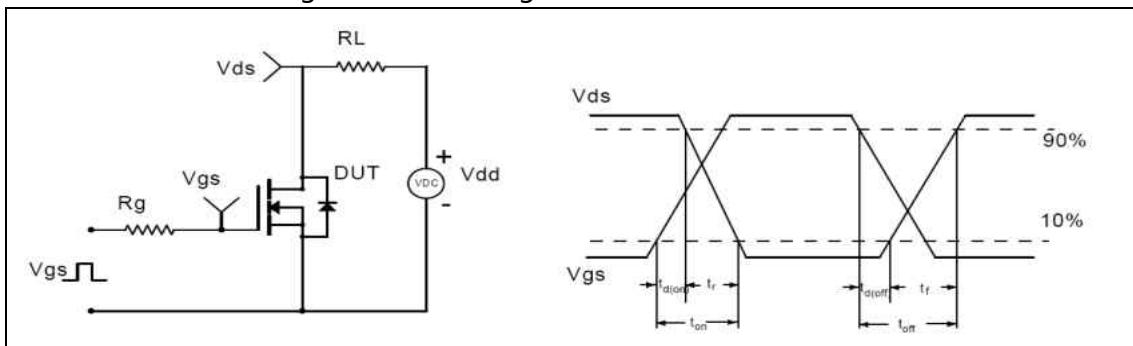


Figure 2, Switching time test circuit & waveforms

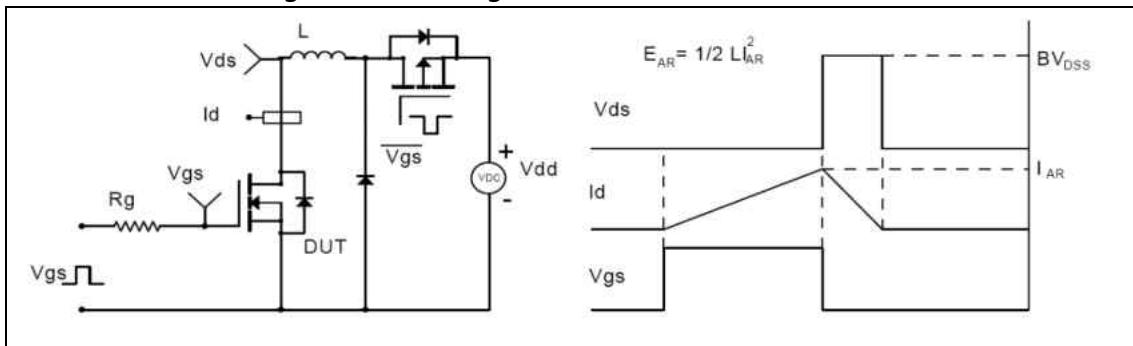


Figure 3, Unclamped inductive switching (UIS) test circuit & waveforms

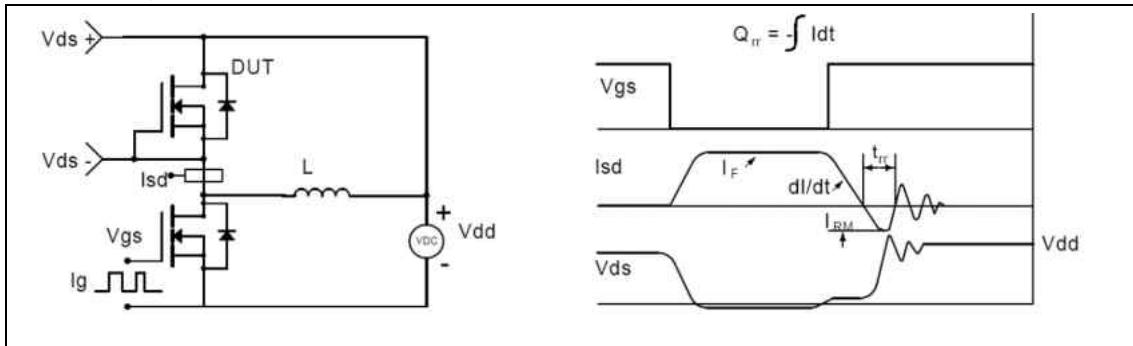
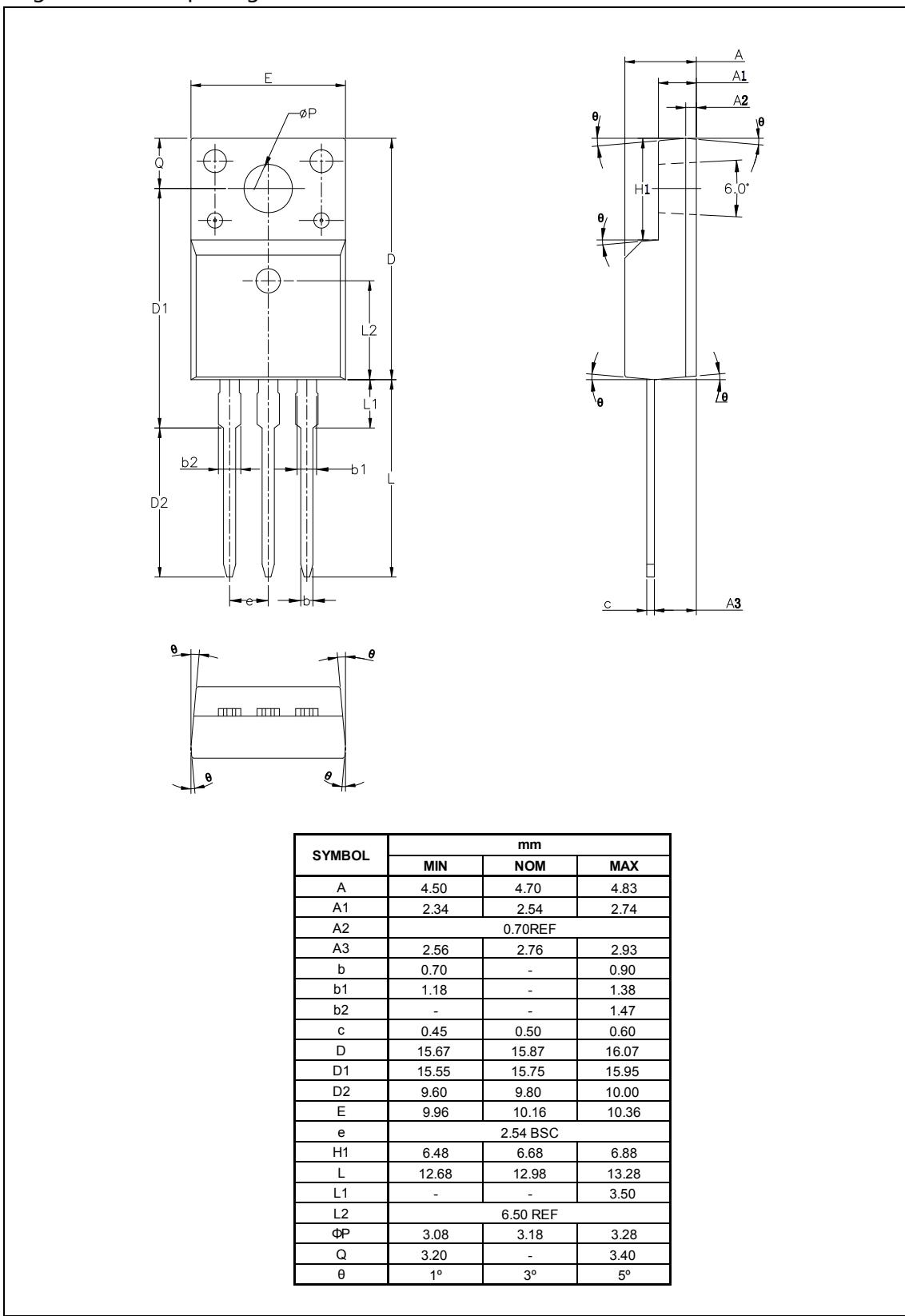


Figure 4, Diode reverse recovery test circuit & waveforms

## ■ Package Information

Figure1, TO220F package outline dimension



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## ■ Ordering Information

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Package	Units/Tube	Tubes/Inner Box	Units/Inner Box	Inner Box/Carton Box	Units/Carton Box
TO220F	50	20	1000	5	5000

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## ■ Product Information

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Product	Package	Pb Free	RoHS	Halogen Free
OSG65R290FTF	TO220F	yes	yes	yes